Supporting Information

Thermoelectric and mechanical properties of environmentally friendly Mg₂Si_{0.3}Sn_{0.67}Bi_{0.03}/SiC composites

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| Area | Mg | Si | Sn | Bi |
|-------------------------|------|------|------|-----|
| 1 | 66.1 | 10.5 | 22.4 | 1.0 |
| 2 | 66.6 | 10.3 | 22.2 | 0.9 |
| 3 | 66.4 | 10.1 | 22.8 | 0.7 |
| Average | 66.3 | 10.3 | 22.5 | 0.9 |
| Nominal composition wt% | 66.7 | 10.0 | 22.3 | 1.0 |

Table S1. Area scan results (percentages) of the $Mg_2Si_{0.30}Sn_{0.67}Bi_{0.03}$ sample.

Table S2. Densities and specific heat of Mg2Si0.30Sn0.67Bi0.03 / SiC composites.

| | Density Archimedes | Theoretical density | |
|---|--------------------|---------------------|-------|
| Sample | $(g.cm^{-1})$ | (%) | Ср |
| Mg2Si0.30Sn0.67Bi0.03 | 3.19 | 99 | 0.524 |
| $Mg_{2}Si_{0.30}Sn_{0.67}Bi_{0.03} + 0.5 \text{ wt-\% SiC}$ | 3.18 | 98 | 0.527 |
| $Mg_{2}Si_{0.30}Sn_{0.67}Bi_{0.03} + 1.0 \text{ wt-\% SiC}$ | 3.19 | 99 | 0.531 |
| $Mg_{2}Si_{0.30}Sn_{0.67}Bi_{0.03} + 1.5 \text{ wt-\% SiC}$ | 3.18 | 98 | 0.535 |
| $Mg_{2}Si_{0.30}Sn_{0.67}Bi_{0.03}+3.0 \text{ wt-\% SiC}$ | 3.18 | 98 | 0.545 |

Equation S1. Hashin model¹.

$$E_{c} = E_{m} \left(\frac{E_{m}V_{m} + E_{r}\{V_{r}+1\}}{E_{r}V_{m} + E_{m}\{V_{r}+1\}} \right),$$

where, E_c is Young's modulus of the composite, E_m is Young's modulus of the matrix, E_r is Young's modulus of the reinforcing phase (E_r equals to 440 GPa)², V_m is volume fraction of the matrix, and V_r is volume fraction of the reinforcing phase (here: SiC).

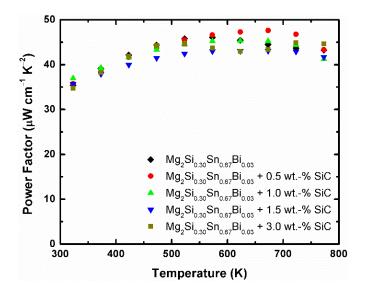


Figure S1. Power factor of Mg2Si0.30Sn0.67Bi0.03 composites with 0, 0.5, 1.0, 1.5, and 3.0 wt.-%

of SiC.

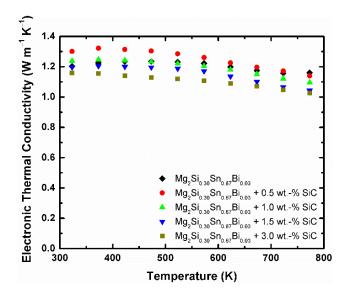


Figure S2. Calculated electronic thermal conductivity of Mg2Si0.30Sn0.67Bi0.03 composites with 0,

0.5, 1.0, 1.5, and 3.0 wt.-% of SiC.

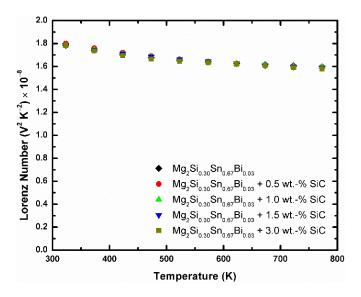


Figure S3. Calculated Lorenz numbers between 300 K and 800 K of Mg₂Si_{0.30}Sn_{0.67}Bi_{0.03} composites with 0, 0.5, 1.0, 1.5, and 3.0 wt.-% of SiC.

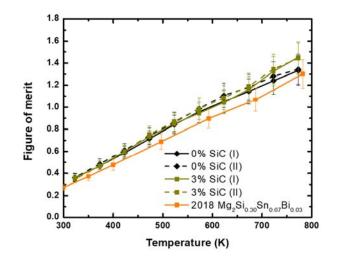


Figure S4. Figure of merit values from the two different pellets of Mg₂Si_{0.30}Sn_{0.67}Bi_{0.03} (black symbols); Mg₂Si_{0.30}Sn_{0.67}Bi_{0.03}/3.0 wt.-% SiC composite (mustard symbols), compared to the 2018 data on Mg₂Si_{0.30}Sn_{0.67}Bi_{0.03} (orange symbol).

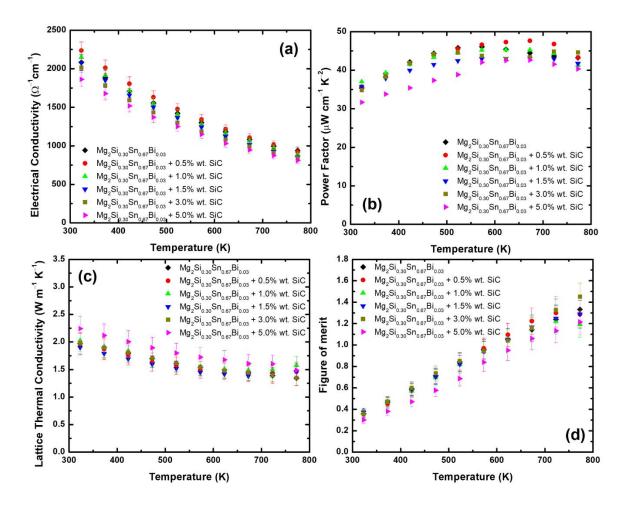


Figure S5. Electrical conductivity, power factor, lattice thermal diffusivity, and figure of merit of Mg₂Si_{0.30}Sn_{0.67}Bi_{0.03} composites with 0, 0.5, 1.0, 1.5, 3.0, and 5.0 wt.-% of SiC.

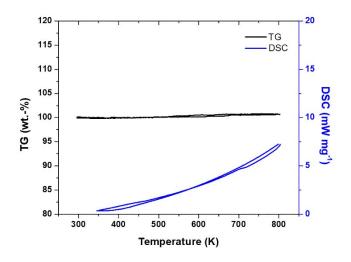


Figure S6. TG and DSC of Mg2Si0.3Sn0.67Bi0.03.

REFERENCES

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